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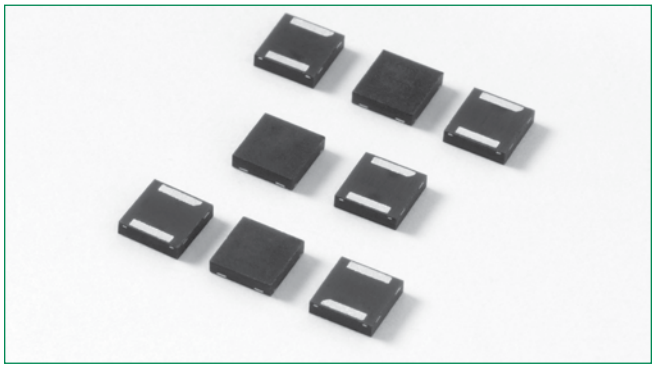
SIDACtor® Protection Thyristors
Broadband Optimized™ Protection

Q2L Series - 3.3x3.3 QFN



Description

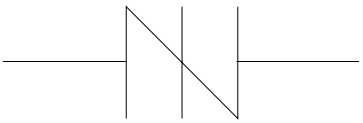
Q2L Series 3.3x3.3 QFN are low capacitance SIDACtor® devices designed to protect high density broadband equipment from damaging overvoltage transients.

The series provides a low profile, chip scale surface mount solution that enables broadband equipment to comply with global regulatory standards while limiting the impact to broadband signals and board space.

Agency Approvals

Agency	Agency File Number
	E133083

Schematic Symbol



Additional Information

Datasheet | Resources | Samples

Features and Benefits

- Low profile
- Small footprint
- Low capacitance
- Low voltage overshoot
- Low on-state voltage
- Does not degrade surge capability after multiple surge events within limit.
- Fails short circuit when surged in excess of ratings
- 2nd level interconnect is Pb-free per IPC/JEDEC J-STD-609A.01
- Recognized to UL 497B as an Isolated Loop Circuit Protector

Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21 Enhanced Level
- ITU K.20/21 Basic Level
- GR 1089 Inter-building
- GR 1089 Intra-building
- IEC 61000-4-5
- YD/T 1082
- YD/T 993
- YD/T 950

Electrical Characteristics

Part Number	Marking	V_{DRM} @I_{DRM}=5µA	V_S @100V/µs	I_H	I_S	I_T	V_T@I_T = 2.2 Amps	Capacitance @1MHz, 2V bias	
		V min	V max	mA min	mA max	A max	V max	pF min	pF max
P0080Q22CLRP	P-8C	6	25	50	800	2.2	5	35	75
P0300Q22CLRP	P03C	25	40	50	800	2.2	5	25	45
P0640Q22CLRP	P06C	58	77	150	800	2.2	5	55	85
P0720Q22CLRP	P07C	65	88	150	800	2.2	5	50	75
P0900Q22CLRP	P09C	75	98	150	800	2.2	5	45	70
P1100Q22CLRP	P11C	90	130	150	800	2.2	5	45	70
P1200Q22CLRP	P12C	100	130	150	800	2.2	5	45	70
P1300Q22CLRP	P13C	120	160	150	800	2.2	5	40	60
P1500Q22CLRP	P15C	140	180	150	800	2.2	5	35	55
P1800Q22CLRP	P18C	170	220	150	800	2.2	5	35	50
P2000Q22CLRP	P20C	180	220	150	800	2.2	5	30	50
P2300Q22CLRP	P23C	190	260	150	800	2.2	5	30	50
P2500Q22CLRP	P25C	230	290	150	800	2.2	5	30	50
P2600Q22CLRP	P26C	220	300	150	800	2.2	5	30	45
P3100Q22CLRP	P31C	275	350	150	800	2.2	5	30	45
P3500Q22CLRP	P35C	320	400	150	800	2.2	5	25	40
P4500Q22CLRP	P45C	400	530	150	800	2.2	5	25	45

Notes:
- Absolute maximum ratings measured at T_A= 25ºC (unless otherwise noted).
- Devices are bi-directional (unless otherwise noted).

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Surge Ratings

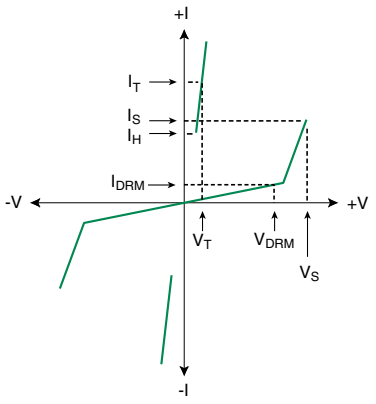
Series	2x10 [1] 2x10 [2]	8x20 [1] 1.2x50 [2]	10x160 [1] 10x160 [2]	10x560 [1] 10x560 [2]	10x1000 [1] 10x1000 [2]	5x310 [1] 10x700 [2]	I_{TSM} 50/60 Hz	di/dt
	A min	A min	A min	A min	A min	A min	A min	A/µs max
C	500	400	200	150	100	200 [3]	30	500

Notes:
1. Current waveform in µs
2. Voltage waveform in µs
3. For surge rating of P4500Q22CLRP 10x700µs min=150A & typical=180A
- Peak pulse current rating (I_{PP}) is repetitive and guaranteed for the life of the product.
- I_{PP} ratings applicable over temperature range of -40ºC to +85ºC
- The device must initially be in thermal equilibrium with -40°C ≤ T_J ≤ +150°C

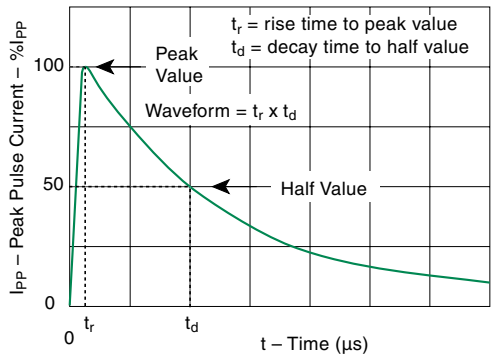
Thermal Considerations

Package	Symbol	Parameter	Value	Unit
3.3 x 3.3 QFN 	T_J	Operating Junction Temperature Range	-40 to +150	°C
	T_S	Storage Temperature Range	-65 to +150	°C
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	120	°C/W

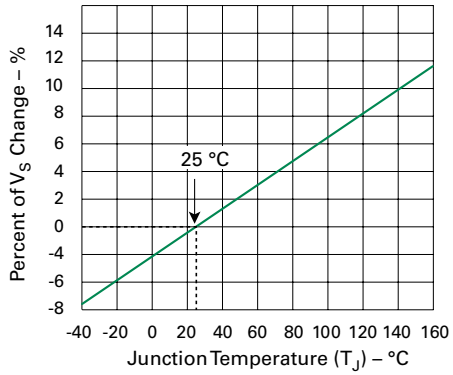
V-I Characteristics



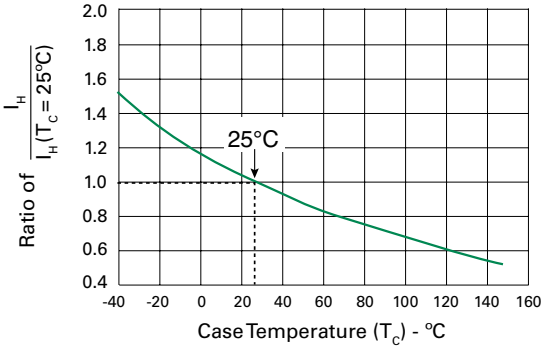
t_r x t_d Pulse Waveform



Normalized V_S Change vs. Junction Temperature



Normalized DC Holding Current vs. Case Temperature



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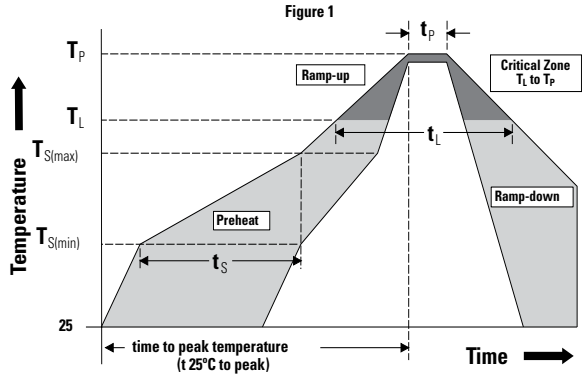
Soldering Parameters

Reflow Condition		Pb-Free assembly
Pre Heat	**- Temperature Min ($T_{s(min)}$)**	+150°C
	- Temperature Max ($T_{s(max)}$)	+200°C
	- Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/sec. Max.
$T_{S(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max.
Reflow	**- Temperature (T_L) (Liquidus)**	+217°C
	- Temperature (t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to Peak Temp (T_P)		8 min. Max.
Do not exceed		+260°C

Figure 1



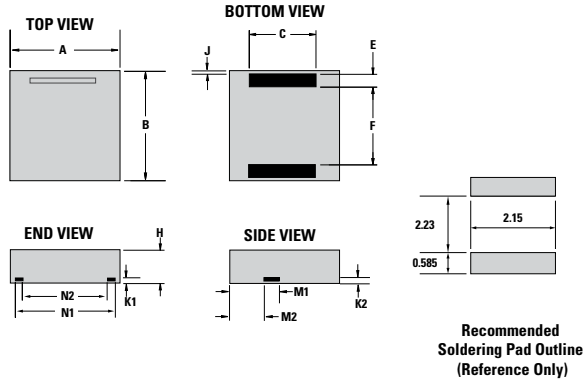
Physical Specifications

Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0

Environmental Specifications

High Temp Voltage Blocking	80% Rated V_{DRM} (V_{AC} Peak) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101
Temp Cycling	-65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104
Biased Temp & Humidity	52 V_{DC} (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101
High Temp Storage	+150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101
Low Temp Storage	-65°C, 1008 hrs.
Thermal Shock	0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106
Resistance to Solder Heat	+260°C, 30 secs. MIL-STD-750 (Method 2031)
Moisture Sensitivity Level	85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1

Dimensions — 3.3x3.3 QFN



Recommended Soldering Pad Outline (Reference Only)

Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.126	0.134	3.200	3.400
B	0.126	0.134	3.200	3.400
C	0.075	0.083	1.900	2.100
E	0.011	0.019	0.285	0.485
F	0.088	0.096	2.230	2.430
H	0.035	0.043	0.900	1.100
J	0.000	0.008	0.000	0.200
K1	0.004	0.012	0.100	0.300
K2	0.004	0.012	0.100	0.300
M1	0.063	0.071	1.610	1.810
M2	0.045	0.053	1.153	1.353
N1	0.095	0.103	2.420	2.620
N2	0.082	0.090	2.080	2.280

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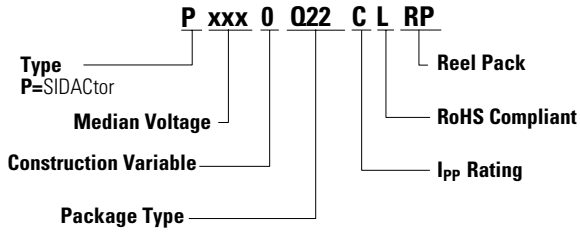
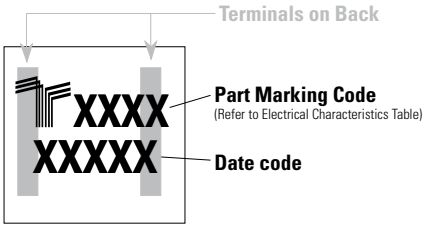
Part Numbering



Part Marking

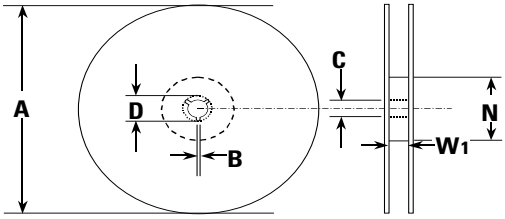


Packing Options

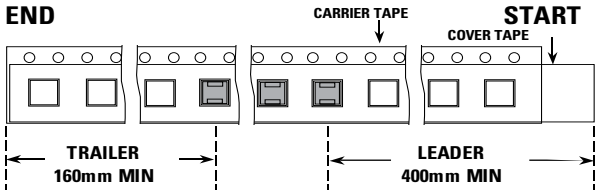
Package Type	Description	Quantity	Added Suffix	Industry Standard
Q22	3.3x3.3 QFN Tape and Reel Pack	5000	RP	EIA-481-D

Tape and Reel Specifications — 3.3x3.3 QFN

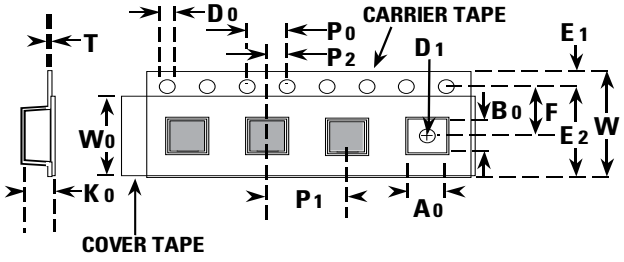
Reel Dimension



Tape Leader and Trailer Dimensions



Tape Dimension Items



Symbols	Description	Inches		Millimeters	
		Min	Max	Min	Max
A	Reel Diameter	N/A	12.992	N/A	330.0
B	Drive Spoke Width	0.059	N/A	1.50	N/A
C	Arbor Hole Diameter	0.504	0.531	12.80	13.50
D	Drive Spoke Diameter	0.795	N/A	20.20	N/A
N	Hub Diameter	1.969	N/A	50.00	N/A
W_1	Reel Inner Width at Hub	0.488	0.567	12.40	14.40
A_0	Pocket Width at Bottom	0.138	0.146	3.50	3.70
B_0	Pocket Length at Bottom	0.138	0.146	3.50	3.70
D_0	Feed Hole Diameter	0.059	0.063	1.50	1.60
D_1	Pocket Hole Diameter	0.059	N/A	1.50	N/A
E_1	Feed Hole Position 1	0.065	0.073	1.65	1.85
E_2	Feed Hole Position 2	0.400	0.408	10.15	10.35
F	Feed Hole Center - Pocket Hole Center 2	0.215	0.219	5.45	5.55
K_0	Pocket Depth	0.039	0.051	1.00	1.30
P_0	Feed Hole Pitch	0.153	0.161	3.90	4.10
P_1	Component Spacing	0.311	0.319	7.90	8.10
P_2	Feed Hole Center - Pocket Hole Center 1	0.077	0.081	1.90	2.05
T	Carrier Tape Thickness	0.010	0.014	0.25	0.35
W	Embossed Carrier Tape Width	0.453	0.484	11.50	12.30
W_0	Cover Tape Width	0.358	0.366	9.10	9.30

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Mouser Electronics

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P0080Q22CLRP P0300Q22CLRP P0640Q22CLRP P0720Q22CLRP P0900Q22CLRP P1100Q22CLRP P1300Q22CLRP P1500Q22CLRP P1800Q22CLRP P2300Q22CLRP P2600Q22CLRP P3100Q22CLRP P3500Q22CLRP P4500Q22CLRP P4500Q22DLHLRP